1-188275-2 ACTIVE

Micro-MaTch | Micro-MaTch Industrial

TE Internal #: 1-188275-2

Ribbon Cable Connectors, Board-to-Board, 12 Position, 1.27 mm [.

05 in] Centerline, Vertical, Surface Mount, 2 Row, Receptacle, Micro-

MaTch Industrial

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors > Female-on-Board Connector, Top Entry











Connector System: Board-to-Board

Number of Positions: 12

Centerline (Pitch): 1.27 mm [.05 in]
PCB Mount Retention: Without
PCB Mount Orientation: Vertical

All Female-on-Board Connector, Top Entry (67)

Features

Product Type Features

| Ribbon Cable Connector Type | Female-on-Board |
|------------------------------------|-----------------------|
| Ribbon Cable Connector Header Type | Shrouded |
| Connector Product Type | Connector Assembly |
| Connector System | Board-to-Board |
| Connector & Housing Type | Receptacle |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features | |
| Number of Positions | 12 |
| PCB Mount Orientation | Vertical |
| Number of Rows | 2 |
| | |

| Insulation Resistance | 1000 ΜΩ |
|-----------------------|------------|
| insulation resistance | 1000 14135 |



| Operating Voltage | 100 VAC |
|---|-------------------------------|
| Body Features | |
| Daisy Chain | Without |
| Primary Product Color | Red |
| Connector Profile | Standard |
| Contact Features | |
| PCB Contact Termination Area Plating Material Thickness | 3 – 5 μm[118.11 – 196.85 μin] |
| Contact Type | Socket |
| Contact Mating Area Plating Material Thickness | 3 – 5 μm[118.11 – 196.85 μin] |
| Contact Mating Area Plating Material | Tin |
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Shape & Form | Dual Beam |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Phosphor Bronze |
| Contact Current Rating (Max) | 1.5 A |
| Termination Features | |
| Rectangular Termination Post & Tail Thickness | .25 mm[.01 in] |
| Rectangular Termination Post & Tail Width | .75 mm[.029 in] |
| Termination Method to Printed Circuit Board | Surface Mount |
| Mechanical Attachment | |
| Mating Alignment | With |
| Contact Retention Type Within Housing | Press-Fit |
| PCB Mount Alignment | Without |
| PCB Mount Retention | Without |
| Mating Alignment Type | Polarization |
| Mating Retention | With |
| Mating Retention Type | Contact Friction |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Mating Entry Location | Тор |
| Housing Material | PA 4.6 |



| Centerline (Pitch) | 1.27 mm[.05 in] |
|---|----------------------------|
| Dimensions | |
| Connector Length | 17.3 mm[.681 in] |
| Connector Height | 5.3 mm[.21 in] |
| Row-to-Row Spacing | 2 mm[.059 in] |
| Usage Conditions | |
| Operating Temperature Range | -40 - 105 °C[-40 - 221 °F] |
| Operation/Application | |
| Solder Process Feature | Board Standoff |
| Circuit Application | Signal |
| Industry Standards | |
| UL Rating | Recognized |
| Compatible With Agency/Standards Products | UL |
| Compatible With Approved Standards Products | UL E28476 |
| UL Flammability Rating | UL 94V-0 |
| | |
| Packaging Features | |
| Packaging Features Packaging Quantity | 900 |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Reflow solder capable to 260°C |

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





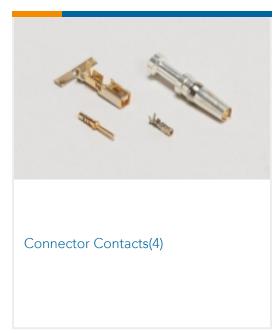


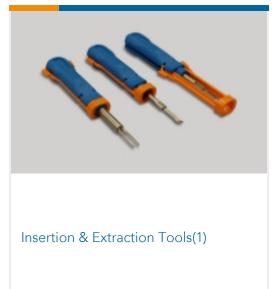




Also in the Series | Micro-MaTch Industrial













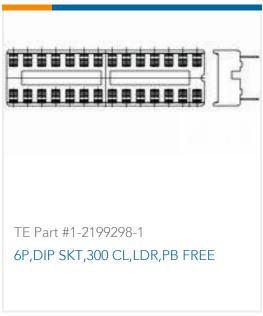
Customers Also Bought















Documents

Product Drawings

MICRO-MATCH SMD FTE

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-188275-2_U.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-188275-2_U.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-188275-2_U.3d_stp.zip

English

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Datasheets & Catalog Pages

Micro-MaTch Catalog

English

Ribbon Cable Interconnect Solutions

English

Centerline Micro-Match Connector Series

English

Product Specifications

Application Specification

English